

MOSMIC[®] for TV-Tuner Prestage with 9 V Supply Voltage

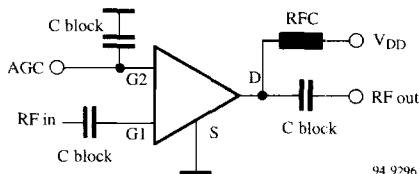
MOSMIC – MOS Monolithic Integrated Circuit

Electrostatic sensitive device.
Observe precautions for handling.



Applications

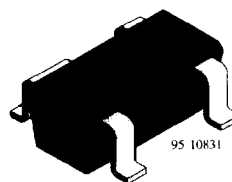
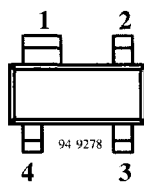
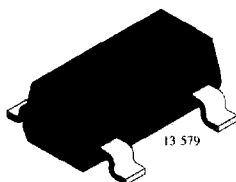
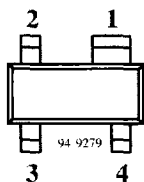
Low noise gain controlled input stages in UHF- and VHF-tuner with 9 V supply voltage.



94 9296

Features

- Integrated gate protection diodes
- Low noise figure
- High gain
- Biasing network on chip
- Improved cross modulation at gain reduction
- High AGC-range
- SMD package



S913T Marking: 913
Plastic case (SOT 143)

1 = Source; 2 = Drain; 3 = Gate 2; 4 = Gate 1

S913TR Marking: 13R
Plastic case (SOT 143R)

1 = Source; 2 = Drain; 3 = Gate 2; 4 = Gate 1

Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
Drain source voltage	V_{DS}	12	V
Drain current	I_D	30	mA
Gate 1 /gate 2-source peak current	$\pm I_{G1/G2SM}$	10	mA
Gate 1 /gate 2-source voltage	$\pm V_{G1/G2SM}$	6	V
Total power dissipation $T_{amb} \leq 60^\circ\text{C}$	P_{tot}	200	mW
Channel temperature	T_{Ch}	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 to +150	$^\circ\text{C}$

Maximum Thermal Resistance

Parameters	Symbol	Maximum	Unit
Channel ambient on glass fibre printed board (25 x 20 x 1.5) mm ³ plated with 35 μm Cu	R_{thChA}	450	K/W

Electrical DC Characteristics

T_{amb} = 25°C

Parameters / Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Gate 1-source breakdown voltage ±I _{G1S} = 10 mA, V _{G2S} = V _{DS} = 0	±V _{(BR)G1SS}	7		10	V
Gate 2-source breakdown voltage ±I _{G2S} = 10 mA, V _{G1S} = V _{DS} = 0	±V _{(BR)G2SS}	7		10	V
Gate 1-source leakage current +V _{G1S} = 5 V, V _{G2S} = V _{DS} = 0	+I _{G1SS}			50	µA
Gate 1-source leakage current -V _{G1S} = 5 V, V _{G2S} = V _{DS} = 0	-I _{G1SS}			100	µA
Gate 2-source leakage current ±V _{G2S} = 5 V, V _{G1S} = V _{DS} = 0	±I _{G2SS}			20	nA
Drain current V _{DS} = 9 V, V _{G1S} = 0 V, V _{G2S} = 4 V	I _{DSS}	50		500	µA
Self-biased operating current V _{DS} = 9 V, V _{G1S} = nc, V _{G2S} = 4 V	I _{DSP}	7	10	14	mA
Gate 2-source cut-off voltage V _{DS} = 9 V, V _{G1S} = nc, I _D = 100 µA	V _{G2S(OFF)}		1.0		V

Electrical AC Characteristics

V_{DS} = 9 V, V_{G2S} = 4 V, f = 1 MHz, T_{amb} = 25°C

Parameters / Test Conditions	Symbol	Min.	Typ.	Max.	Unit
Forward transadmittance	y _{21S}	20	24	28	mS
Gate 1 input capacitance	C _{issg1}		2.1	2.5	pF
Feedback capacitance	C _{rss}		20		fF
Output capacitance	C _{oss}		0.9		pF
Power gain g _S = 2 mS, g _L = 0.5 mS, f = 200 MHz	G _{ps}		26		dB
g _S = 3.3 mS, g _L = 1 mS, f = 800 MHz	G _{ps}	16.5	20		dB
AGC range V _{DS} = 9 V, V _{G2S} = 1 to 4 V, f = 800 MHz	ΔG _{ps}	40			dB
Noise figure g _S = 2 mS, g _L = 0.5 mS, f = 200 MHz	F		1		dB
g _S = 3.3 mS, g _L = 1 mS, f = 800 MHz	F		1.3		dB

Caution for Gate 1 switch-off mode:

No external DC-voltage on Gate 1 in active mode!

Switch-off at Gate 1 with V_{G1S} < 0.7 V is feasible.

Using open collector switching transistor (inside of PLL), insert 10 kΩ collector resistor.

S913T/S913TR

Common Source S-Parameters

$V_{DS} = 9\text{ V}$; $V_{G2S} = 4\text{ V}$

f/MHz	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG
	dB	deg	dB	deg	dB	deg	dB	deg
50	-0.02	-4.1	7.50	174.9	-63.74	88.2	-0.13	-1.6
100	-0.04	-7.9	7.41	169.0	-57.58	85.0	-0.14	-3.0
150	-0.12	-11.9	7.31	162.9	-54.15	82.1	-0.16	-4.5
200	-0.19	-15.7	7.20	157.3	-51.78	79.3	-0.18	-5.8
250	-0.29	-19.7	7.07	150.8	-50.15	76.8	-0.20	-7.6
300	-0.41	-23.1	6.94	145.8	-48.89	75.0	-0.24	-8.9
350	-0.52	-26.8	6.71	140.0	-47.92	72.9	-0.27	-10.2
400	-0.66	-30.3	6.59	134.8	-47.25	71.2	-0.31	-11.7
450	-0.81	-33.6	6.34	129.9	-46.77	69.8	-0.35	-12.9
500	-0.97	-36.9	6.17	124.6	-46.47	68.5	-0.40	-14.5
550	-1.12	-40.3	5.96	119.7	-46.32	67.8	-0.44	-15.7
600	-1.28	-43.3	5.74	114.7	-46.34	68.8	-0.49	-17.0
650	-1.42	-46.5	5.55	110.6	-46.24	70.0	-0.54	-18.2
700	-1.55	-49.6	5.36	105.8	-46.36	71.0	-0.57	-19.4
750	-1.70	-52.4	5.17	101.5	-46.67	72.9	-0.62	-20.8
800	-1.87	-55.4	4.98	97.0	-47.12	76.2	-0.66	-22.0
850	-1.99	-58.4	4.84	93.0	-47.41	81.6	-0.71	-23.3
900	-2.11	-61.3	4.68	88.4	-47.72	89.3	-0.74	-24.8
950	-2.24	-64.2	4.52	84.5	-47.55	98.3	-0.79	-25.9
1000	-2.38	-67.1	4.31	80.3	-47.07	104.4	-0.86	-27.3
1050	-2.50	-69.9	4.14	75.8	-46.96	110.4	-0.95	-28.4
1100	-2.67	-72.8	3.96	71.9	-46.72	119.7	-0.98	-29.7
1150	-2.72	-75.7	3.90	67.6	-45.93	128.4	-1.01	-31.1
1200	-2.85	-78.5	3.80	64.2	-44.91	137.0	-1.03	-32.4
1250	-2.95	-81.4	3.67	60.0	-43.76	144.2	-1.06	-33.8
1300	-3.06	-84.4	3.55	55.7	-42.39	149.1	-1.15	-35.0

Typical Characteristics ($T_j = 25^\circ\text{C}$ unless otherwise specified)

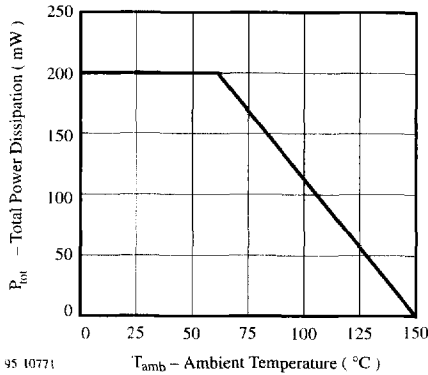


Figure 1. Total Power Dissipation vs. Ambient Temperature

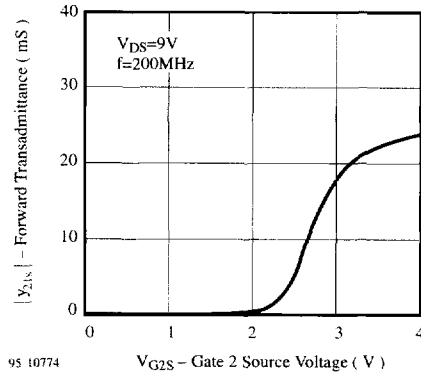


Figure 4. Forward-Transmittance vs. Gate 2 Source Voltage

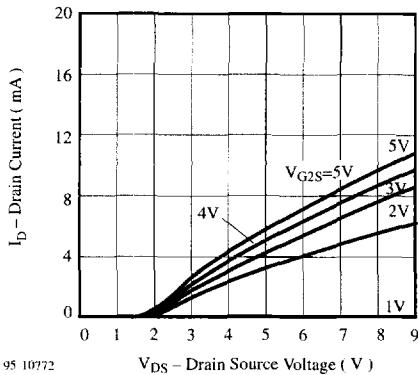


Figure 2. Drain Current vs. Drain Source Voltage

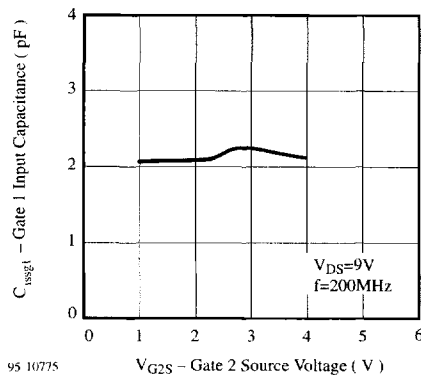


Figure 5. Input Capacitance vs. Gate 2 Source Voltage

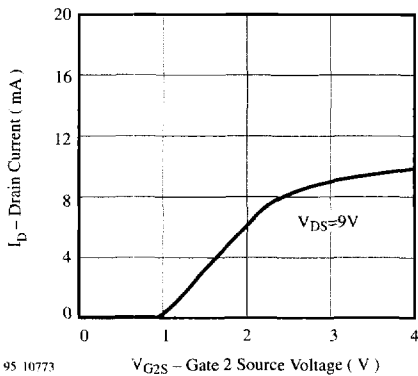


Figure 3. Drain Current vs. Gate 2 Source Voltage

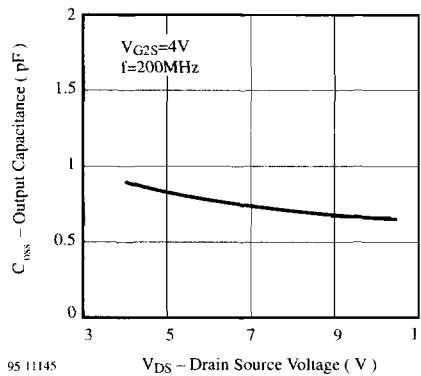


Figure 6. Output Capacitance vs. Drain Source Voltage

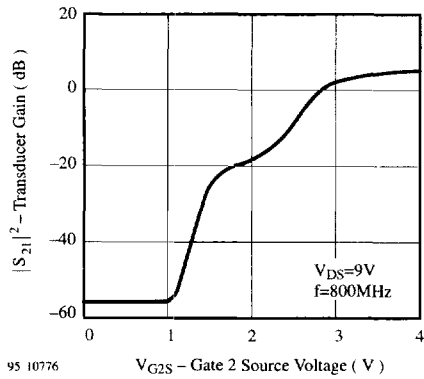


Figure 7. Transducer Gain vs. Gate 2 Source Voltage

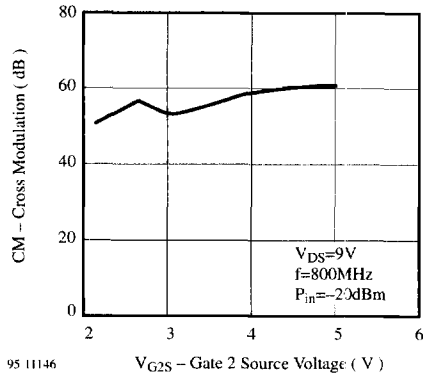


Figure 8. Cross Modulation vs. Gate 2 Source Voltage

$V_{DS} = 9 \text{ V}$; $V_{G2S} = 4 \text{ V}$; $Z_0 = 50 \ \Omega$

S_{11}

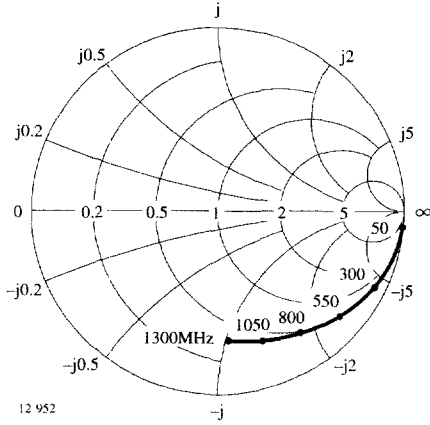


Figure 9. Input reflection coefficient

S_{12}

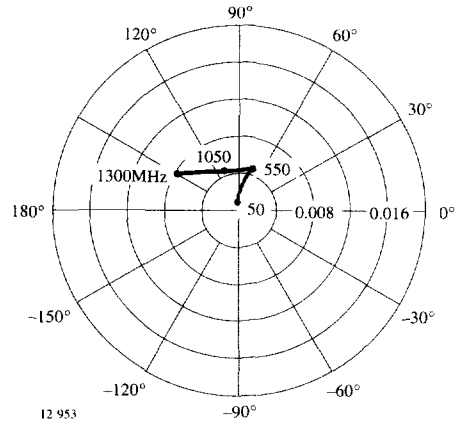


Figure 11. Reverse transmission coefficient

S_{21}

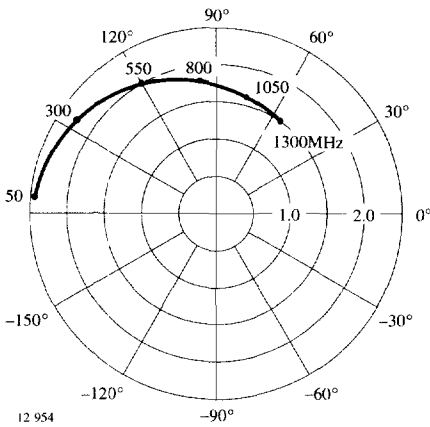


Figure 10. Forward transmission coefficient

S_{22}

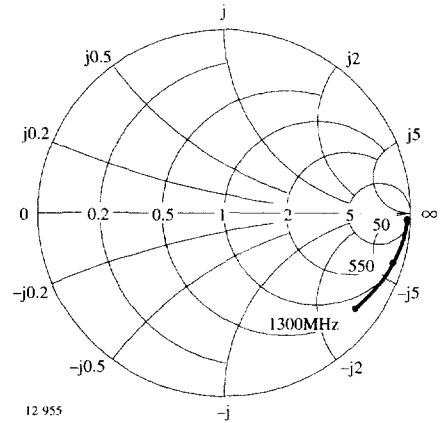
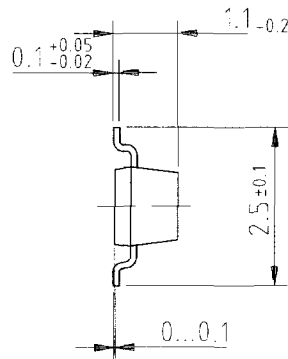
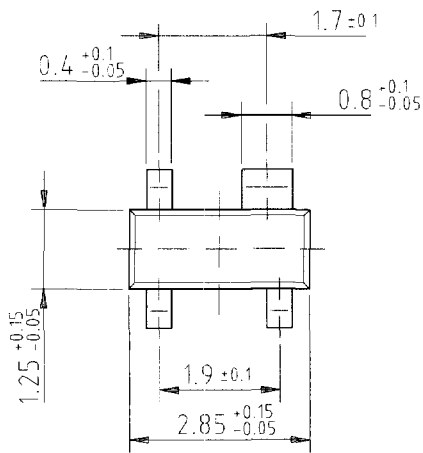


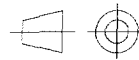
Figure 12. Output reflection coefficient

S913T/S913TR

Dimensions of S913T in mm

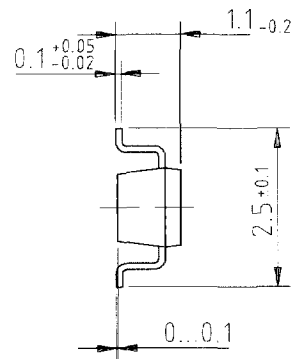
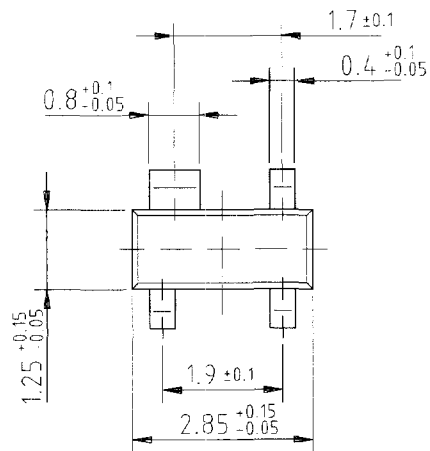


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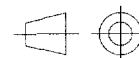


technical drawings
according to DIN
specifications

Dimensions of S913TR in mm



96 12239



technical drawings
according to DIN
specifications